

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Board Level Cooling - Channel 7130



BOARD LEVEL COOLING - Channel 7130

Channel 7130 is a series of channel board level heat sinks designed to cool TO-220 and TO-220-single gauge devices. Representative image only.



ORDERING INFORMATION

Part Number	Device Type	
7136DG	TO-220, TO-220-single gauge	
7139DG	TO-220, TO-220-single gauge	



HEAT SINK DETAILS

USA: 1.855.322.2843

EUROPE: 39.051.764002

Property	Details		
Material	Copper		
Finish	Tin Plated		
Device Attachment Options	Integrated Mounting Clip		
Thermal Interface Material	-		

Property	Details		
Heat Sink Width (mm)	13.21		
Heat Sink Length (mm)	13.08		
Heat Sink Height (mm)	See "A" Dim below		
Heat Sink Mounting Direction	Vertical, Horizontal		

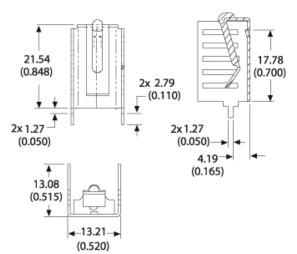
Mounting Details:

MECHANICAL & PERFORMANCE

Drawing dimensions are shown in mm, (in)

Part Number	"A" Dim	"X" Dim	"Y" Dim	"Z" Dim
7136DG	21.54	6.30 (0.248)	4.83 (0.190)	2.54 (0.100)
7139DG	19.81	-	1.40 (0.055)	2.54 (0.100)

Part Number: 7136DG

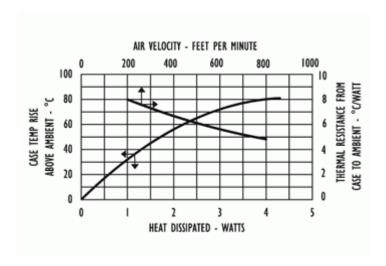


Device Centerline Mounting Surface of Heat Sink Typical Device Lead Locations Ø Z1 (2 Places)

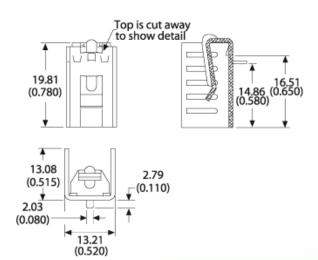
ASIA: 86.21.6115.2000 x8122



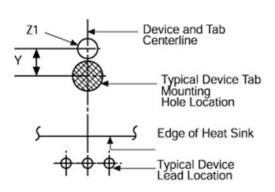
Board Level Cooling – Channel 7130

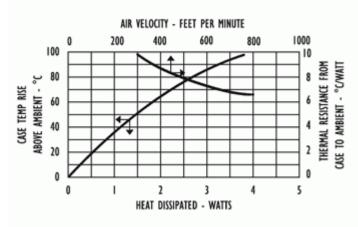


Part Number: 7139DG



Mounting Details:





USA: 1.855.322.2843 EUROPE: 39.051.764002 ASIA: 86.21.6115.2000 x8122

